



⟨EMC Shielding Adhesive Tapes⟩

Metal foil type tapes AL7080 • CU7040

Metal foil type conductive tapes CU7636R • CU7636D

Conductive adhesive transfer tapes T4420W

Conductive adhesive double coated tapes AL7620 · AL7621

Metal foil type conductive tapes AL7650

Features

■ Suitable for the shielding use in housing of mobile devices. Offers wide ranging solutions with the combination of metallic foil and adhesive.

AL7080: Shiny aluminum foil with single coated adhesive CU7040: Electrolytic copper foil with single coated adhesive

CU7636R: Rolled copper foil with single coated conductive adhesive to enable conduction in the

thickness direction

CU7636D: Electrolytic copper foil with single coated conductive adhesive to enable conduction in the

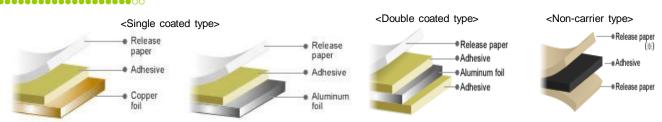
thickness direction

AL7650: Aluminum foil with shingle coated conductive adhesive

AL7620 · AL7621: Aluminum foil with double coated conductive adhesive

T4420W: Conductive adhesive transfer tape (non-carrier type)

Structure



Product	CU7040	AL7080	CU7636R	CU7636D	AL7650	AL7620	AL7621	T4420W *
name Type	Single	Single	Single	Single	Single	Double	Double	Non-carrier
Main	coated	coated	coated Conductive	coated Conductive	coated Conductive	coated Conductive	coated Conductive	Conductive
component	Acrylic	Acrylic	acrylic	acrylic	acrylic	acrylic	acrylic	acrylic
Carrier	Electrolysis	Soft	Rolling	Electrolysis	Soft	Soft	Soft	
	copper foil	aluminum foil	copper foil	copper foil	aluminum foil	aluminum foil	aluminum foil	Non-carrier
	35µm	80µm	35µm	35µm	50µm	20µm	20µm	-
Color	Copper	Aluminum	Copper	Copper	Aluminum	Aluminum	Aluminum	Black
Adhesive thickness(µm)	About 85	About 120	About 70	About 70	About 75	About 70	About 50	About 35
Release paper thickness (µm)	About 115	About 115	About 115	About 115	About 120	About 120	About 120	About 115 表 115
Bonding strength (N/20mm) *2	26	20	7	8	11	9	8	6
St'd size	500mm	500mm	500mm	500mm	500mm	500mm	500mm	500mm
(width × length)	× 50m	× 50m	× 25m	× 25m	× 50m	× 50m	× 50m	× 100m

^{*} T4420Wis with both side release paper.

^{*2 180°} peeling strength



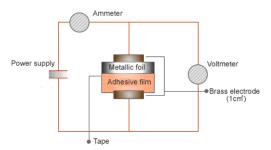
Suitable use

- Ideal for shielding the interior of mobile devices such as computers cellular phones.
- Ideal for heat and light reflection use.

Technical data

1. Resistance of each product

<Measuring method>



Adjust the ampere to 0.1A power supply, then measure the voltage between both electrodes to compute the resistance with a formula, $R\!=\!E/L$

<Results>

Voltage	CU7040	AL7080	CU7636R	CU7636D	AL7650	AL7620	Al7621	T4420W
Resistance (Ω) *Thickness direction	_	_	0.07	0.07	0.30	0.40	0.20	0.07

2. The shielding effects of each product

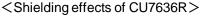
<Measuring method>

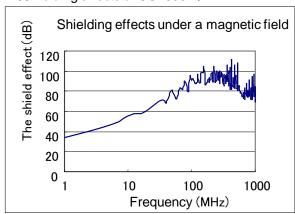
Shielding effects of the products under a magnetic or electric field were measured using a device for measuring electromagnetic wave shielding effect (the KEC method).

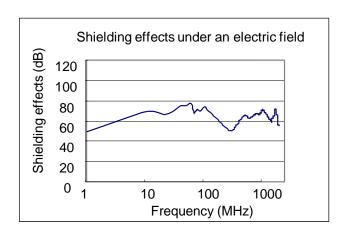
<Results>

	Voltage	CU7040	AL7080	CU7636R	CU7636D	AL7650	AL7620
Shielding effects	30MHz	64	70	69	73	70	73
under an electric field	100MHz	87	79	73	69	84	76
(dB)	300MHz	86	82	50	50	68	73
Shielding effects	30MHz	71	58	70	68	62	52 /
under a magnetic field	100MHz	68	65	90	78	63	50. 64
(dB)	300MHz	70	70	96	83	68	67

Shield tape TDS-041







3. Bonding strength under each temperature (180° peeling strength)

<Test piece condition>

Substrate: Stainless steel plate (SUS304)

Tape width: 20mm

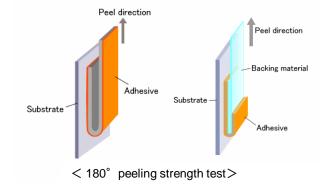
Bonding condition: One stroke with 2-kg roller Measurement temperature: -10°C ~ 100°C

Peeling speed: 300mm/min

Backing material: 25µmPET (AL7620 Only)

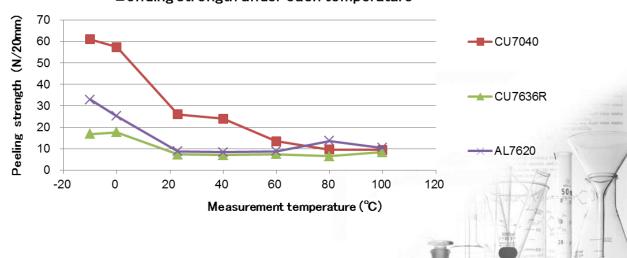
[Left at RT for one day and then at each temperature

for 30 minutes before measurement.]



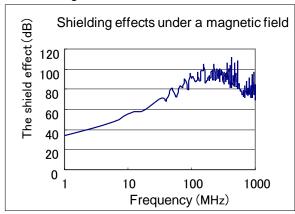
<Results>

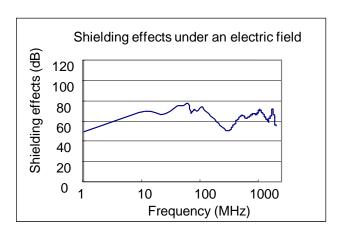
Bonding strength under each temperature



Shield tape TDS-04

<Shielding effects of CU7636R>





3. Bonding strength under each temperature (180° peeling strength)

<Test piece condition>

Substrate: Stainless steel plate (SUS304)

Tape width: 20mm

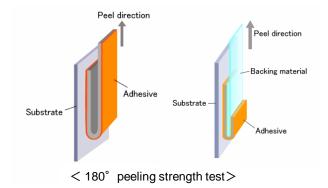
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Peeling speed: 300mm/min

Backing material: 25µmPET (AL7620 Only)

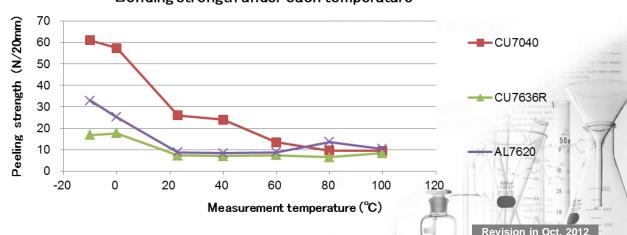
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<Results>

Bonding strength under each temperature



Note on the characteristic data given— Data on the characteristics of the products described in this catalog are based on the results of evaluations carried out by the company. This does not guarantee that the characteristics of the product conform with your usage environment. Before use, review the usage conditions based on evaluation data obtained from the equipment and substrates actually used.

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